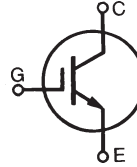


# HiPerFAST™ High Speed IGBT C2-Class

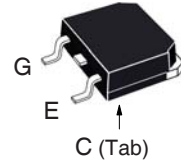
**IXGH50N60C2**  
**IXGT50N60C2**

**V<sub>CES</sub> = 600V**  
**I<sub>C110</sub> = 50A**  
**V<sub>CE(sat)</sub> ≤ 2.7V**  
**t<sub>fi(typ)</sub> = 48ns**

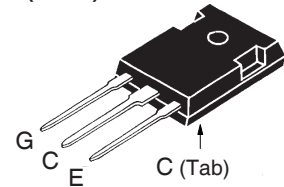


Symbol	Test Conditions	Maximum Ratings	
V <sub>CES</sub>	T <sub>J</sub> = 25°C to 150°C	600	V
V <sub>CGR</sub>	T <sub>J</sub> = 25°C to 150°C, R <sub>GE</sub> = 1MΩ	600	V
V <sub>GES</sub>	Continuous	±20	V
V <sub>GEM</sub>	Transient	±30	V
I <sub>C25</sub>	T <sub>C</sub> = 25°C (Limited by Leads)	75	A
I <sub>C110</sub>	T <sub>C</sub> = 110°C	50	A
I <sub>CM</sub>	T <sub>C</sub> = 25°C, 1ms	300	A
<b>SSOA</b> <b>(RBSOA)</b>	V <sub>GE</sub> = 15V, T <sub>VJ</sub> = 125°C, R <sub>G</sub> = 10Ω Clamped Inductive Load	I <sub>CM</sub> = 80 @V <sub>CE</sub> ≤ V <sub>CES</sub>	A
P <sub>C</sub>	T <sub>C</sub> = 25°C	400	W
T <sub>J</sub>		-55 ... +150	°C
T <sub>JM</sub>		150	°C
T <sub>stg</sub>		-55 ... +150	°C
T <sub>L</sub>	Maximum Lead Temperature for Soldering	300	°C
T <sub>SOLD</sub>	1.6 mm (0.062in.) from Case for 10s	260	°C
M <sub>d</sub>	Mounting Torque	1.13/10	Nm/lb.in
Weight	TO-268	4	g
	TO-247	6	g

TO-268 (IXGT)



TO-247 (IXGH)



G = Gate      C = Collector  
E = Emitter    Tab = Collector

## Features

- Very High Frequency IGBT
- Square RBSOA
- High Current Handling Capability
- International Standard Packages

## Advantages

- High Power Density
- Low Gate Drive Requirement

## Applications

- Switch-Mode and Resonant-Mode Power Supplies
- Uninterruptible Power Supplies (UPS)
- PFC Circuits
- AC Motor Drives
- DC Servo & Robot Drives
- DC Choppers

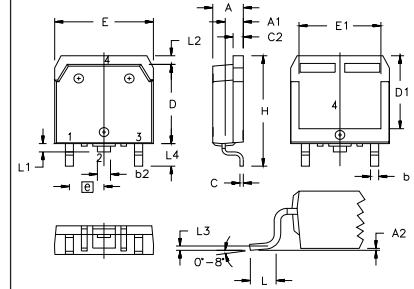
Symbol	Test Conditions (T <sub>J</sub> = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV <sub>CES</sub>	I <sub>C</sub> = 250μA, V <sub>GE</sub> = 0V	600		V
V <sub>GE(th)</sub>	I <sub>C</sub> = 250μA, V <sub>CE</sub> = V <sub>GE</sub>	3.0		V
I <sub>CES</sub>	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0V T <sub>J</sub> = 125°C			50 μA 1 mA
I <sub>GES</sub>	V <sub>CE</sub> = 0V, V <sub>GE</sub> = ±20V			±100 nA
V <sub>CE(sat)</sub>	I <sub>C</sub> = 40A, V <sub>GE</sub> = 15V, Note 1 T <sub>J</sub> = 125°C	1.8		2.7 V V

**Symbol Test Conditions**
 $(T_J = 25^\circ\text{C Unless Otherwise Specified})$ 
**Characteristic Values**

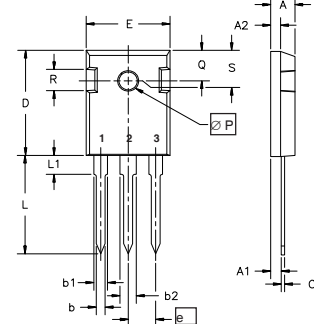
		Min.	Typ.	Max.	
$g_{fs}$	$I_C = 40\text{A}, V_{CE} = 10\text{V}, \text{Note 1}$	40	51		S
$C_{ies}$	$V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$		3700		pF
$C_{oes}$			230		pF
$C_{res}$			50		pF
$Q_{g(on)}$	$I_C = 40\text{A}, V_{GE} = 15\text{V}, V_{CE} = 0.5 \cdot V_{CES}$		138		nC
$Q_{ge}$			25		nC
$Q_{gc}$			40		nC
$t_{d(on)}$	<b>Inductive load, <math>T_J = 25^\circ\text{C}</math></b> $I_C = 40\text{A}, V_{GE} = 15\text{V}$		18		ns
$t_{ri}$			25		ns
$t_{d(off)}$	$V_{CE} = 0.8 \cdot V_{CES}, R_G = 2\Omega$		115	150	ns
$t_{fi}$		Note 2	48		ns
$E_{off}$		0.38	0.70		mJ
$t_{d(on)}$	<b>Inductive load, <math>T_J = 125^\circ\text{C}</math></b> $I_C = 40\text{A}, V_{GE} = 15\text{V}$		18		ns
$t_{ri}$			25		ns
$E_{on}$	$V_{CE} = 0.8 \cdot V_{CES}, R_G = 2\Omega$		1.4		mJ
$t_{d(off)}$		Note 2	170		ns
$t_{fi}$		60		ns	
$E_{off}$		0.74		mJ	
$R_{thJC}$				0.31	$^\circ\text{C/W}$
$R_{thCS}$	TO-247	0.21			$^\circ\text{C/W}$

**Notes:**

1. Pulse test,  $t \leq 300\mu\text{s}$ , duty cycle,  $d \leq 2\%$ .
2. Switching times & energy losses may increase for higher  $V_{CE}(\text{clamp})$ ,  $T_J$  or  $R_G$ .

**TO-268 Outline**

 Terminals: 1 - Gate, 2, 4 - Collector  
 3 - Emitter

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.193	.201	4.90	5.10
A1	.106	.114	2.70	2.90
A2	.001	.010	0.02	0.25
b	.045	.057	1.15	1.45
b2	.075	.083	1.90	2.10
C	.016	.026	0.40	0.65
C2	.057	.063	1.45	1.60
D	.543	.551	13.80	14.00
D1	.488	.500	12.40	12.70
E	.624	.632	15.85	16.05
E1	.524	.535	13.30	13.60
e	.215 BSC		5.45 BSC	
H	.736	.752	18.70	19.10
L	.094	.106	2.40	2.70
L1	.047	.055	1.20	1.40
L2	.039	.045	1.00	1.15
L3	.010 BSC		0.25 BSC	
L4	.150	.161	3.80	4.10

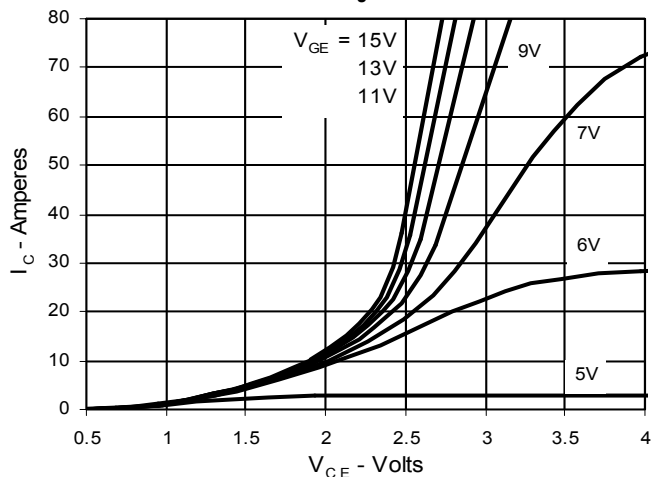
**TO-247 Outline**

 Terminals: 1 - Gate, 2 - Collector  
 3 - Emitter

Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.7	5.3	.185	.209
A <sub>1</sub>	2.2	2.54	.087	.102
A <sub>2</sub>	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b <sub>1</sub>	1.65	2.13	.065	.084
b <sub>2</sub>	2.87	3.12	.113	.123
C	.4	.8	.016	.031
D	20.80	21.46	.819	.845
E	15.75	16.26	.610	.640
e	5.20	5.72	0.205	0.225
L	19.81	20.32	.780	.800
L1		4.50		.177
∅P	3.55	3.65	.140	.144
Q	5.89	6.40	0.232	0.252
R	4.32	5.49	.170	.216
S	6.15 BSC		242 BSC	

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

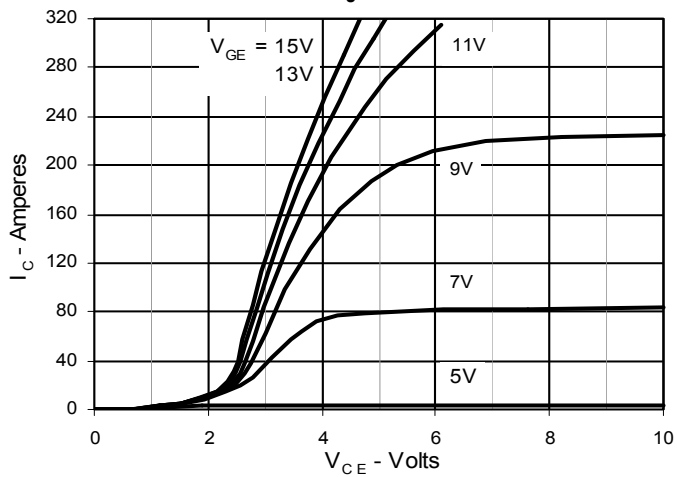
**Fig. 1. Output Characteristics**

@  $T_J = 25^\circ\text{C}$



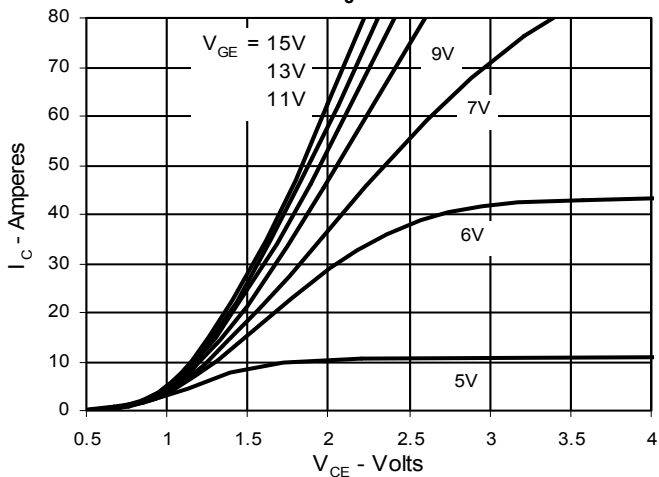
**Fig. 2. Extended Output Characteristics**

@  $T_J = 25^\circ\text{C}$

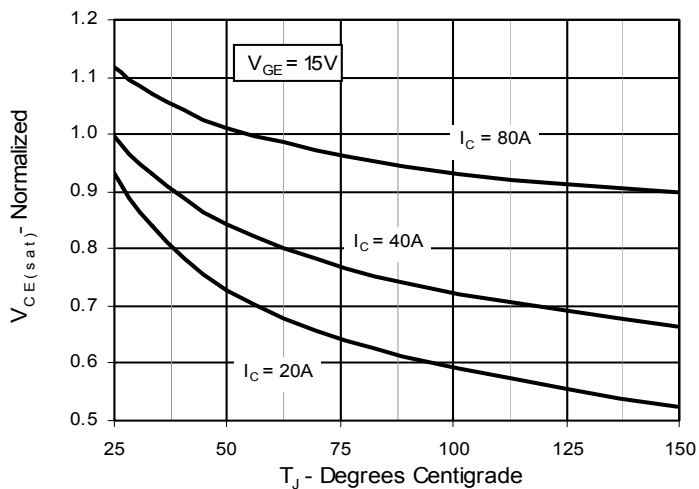


**Fig. 3. Output Characteristics**

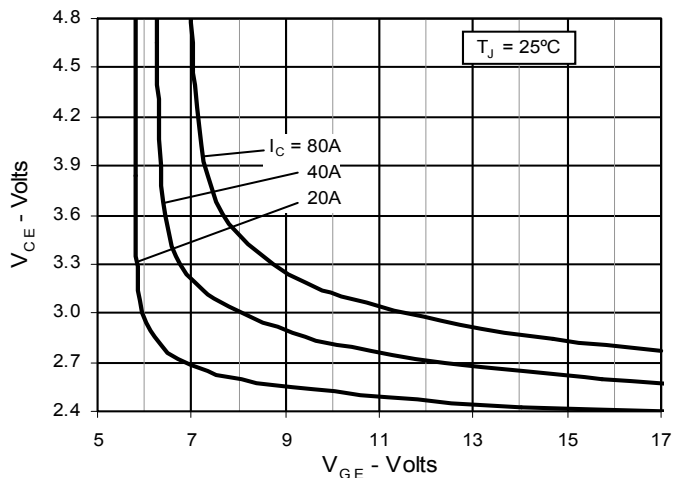
@  $T_J = 125^\circ\text{C}$



**Fig. 4. Dependence of  $V_{CE(sat)}$  on Temperature**



**Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter voltage**



**Fig. 6. Input Admittance**

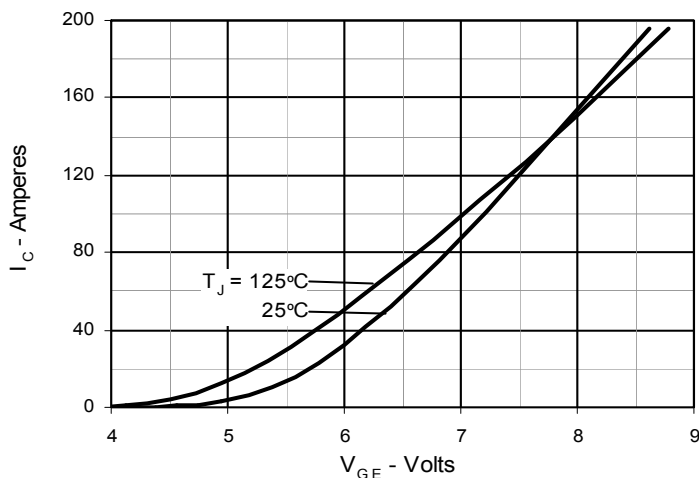


Fig. 7. Transconductance

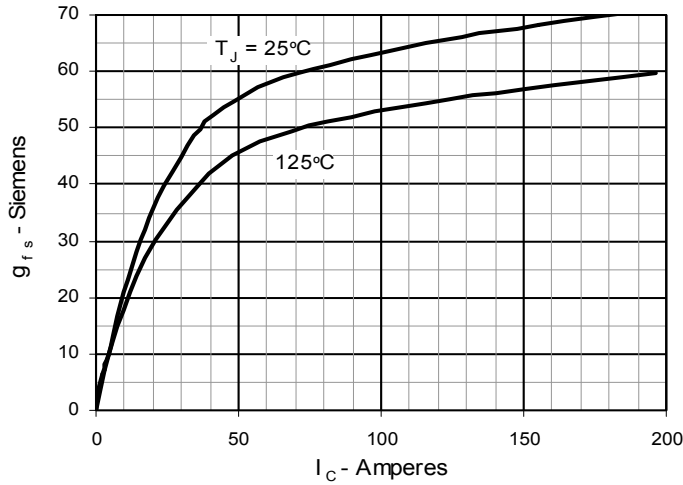


Fig. 8. Dependence of Turn-Off Energy on  $R_G$

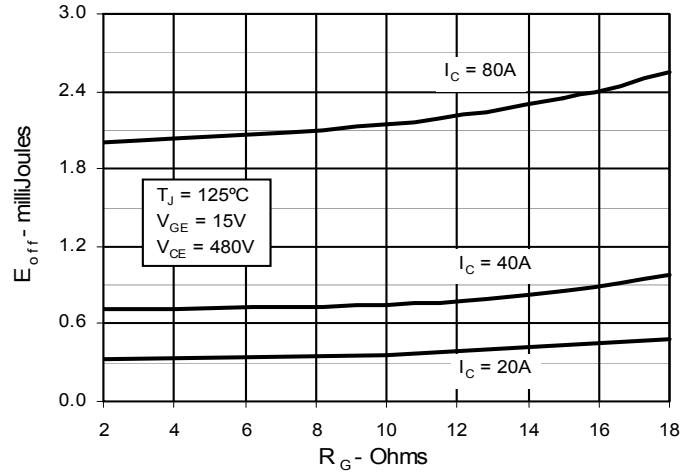


Fig. 9. Dependence of Turn-Off Energy on  $I_C$

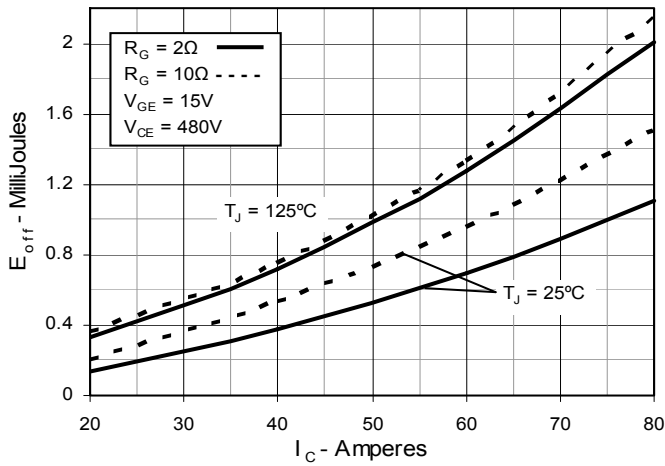


Fig. 10. Dependence of Turn-Off Energy on Temperature

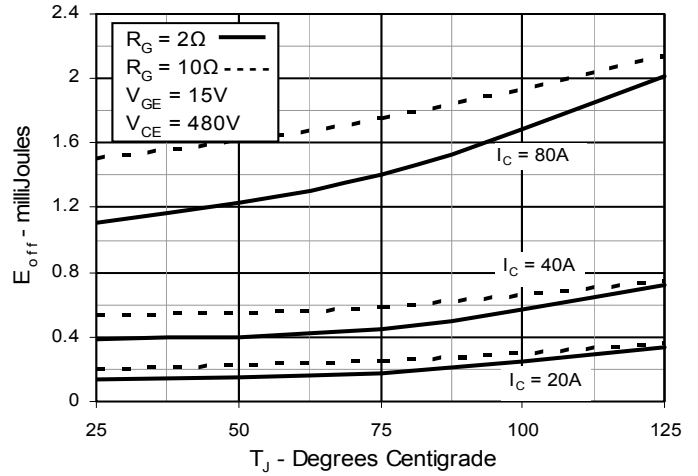


Fig. 11. Dependence of Turn-Off Switching Time on  $R_G$

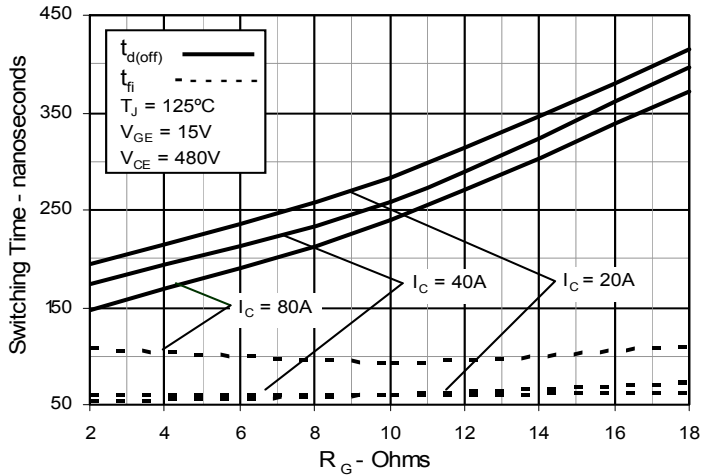
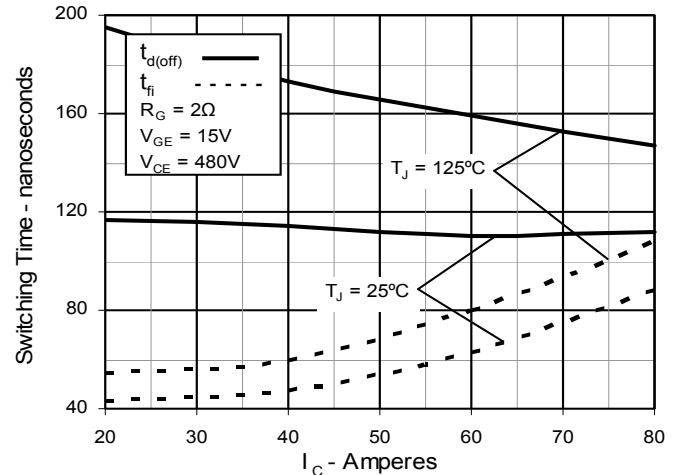
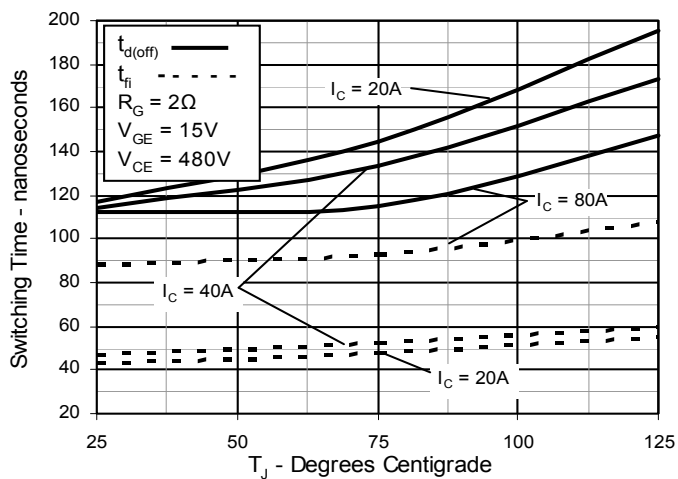


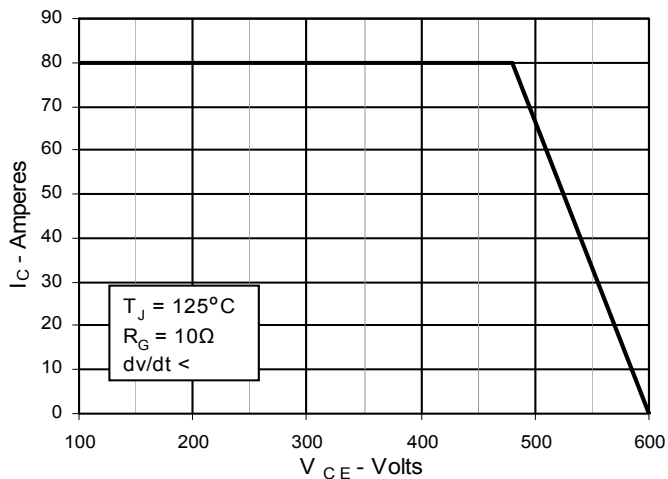
Fig. 12. Dependence of Turn-Off Switching Time on  $I_C$



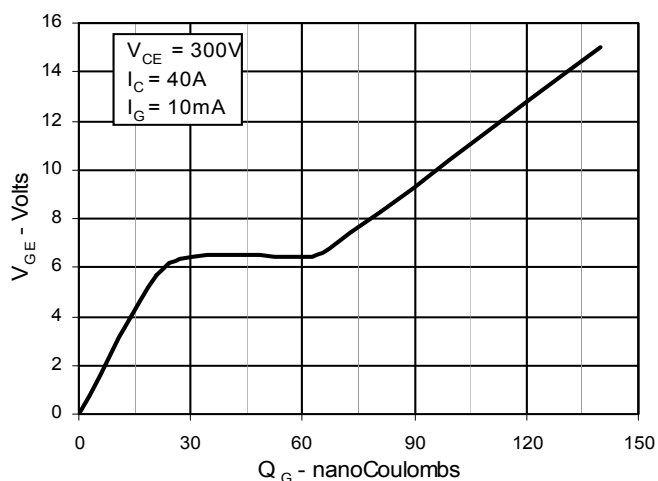
**Fig. 13. Dependence of Turn-Off Switching Time on Temperature**



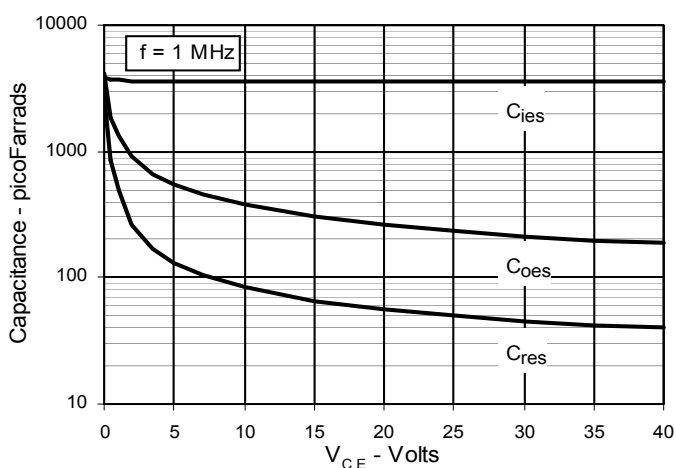
**Fig. 14. Reverse-Bias Safe Operating Area**



**Fig. 15. Gate Charge**



**Fig. 16. Capacitance**



**Fig. 17. Maximum Transient Thermal Resistance**

